

QMS-052-06.75-L-D-PC4 QMS-078-05.75-L-D-RF1

(0,635 mm) .025"

QMS-PC, QMS-RF SERIES

HIGH SPEED COMBO RF & POWER

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?QMS

Insulator Material: Liquid Crystal Polymer Terminal & Ground

Plane Material: Phosphor Bronze **Plating:**

Au over 50μ" (1,27 μm) Ni (Tin on Ground Plane Tail) Current Rating: Signal Contact

1.8A per signal contact@ 80°C Power Contact:

4.1A per power contact@ 80°C Ground Plane: 8.9A per ground contact@ 80°C

Voltage Rating:

300 VAC mated with QFS Operating Temp: 55°C to +125°C

RoHS Compliant: Yes

Processing: Lead-Free Solderable: Yes SMT Lead Coplanarity: (0,10 mm) .004" max (026-078) Board Stacking:

For applications requiring more than two connectors per board, contact ipg@samtec.com

APPLICATION SPECIFIC OPTION

- Differential Pairs
- Retention Pins
- 8 Power Pins/End for (1,60 mm) 0.62" thick Board
- 4 or 8 Power Pins/End for (2,36 mm) .093" thick Board
- 2 RF Connectors/End
- Hot Pluggable

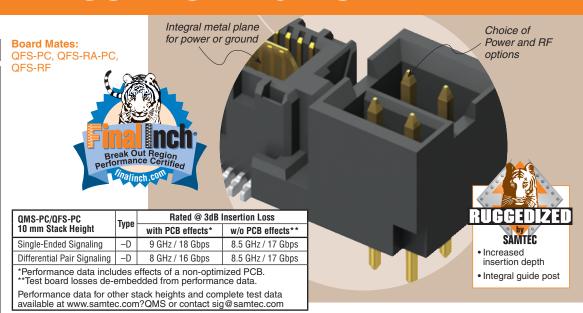
Call Samtec.

APPLICATIONS



See SO Series for precision machined standoffs.

Note: Some lengths. styles and options are non-standard, non-returnable.



026, -052, -078(52 toťal pins per bank)

QMS

NO. OF PINS

PER ROW

Specify LEAD **STYLE** from chart

Α

(5,38)

.212

LEAD

STYLE

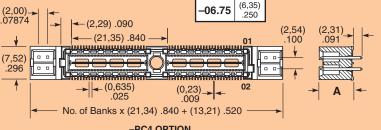
= 10μ" (0,25 μm) Gold on Signal Pins and Ground Plane

PLATING

OPTION

(Tin on Signal Pin tails, and Ground Plane tails)

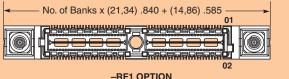
= 4 Power Pins per End for (1,60 mm) .062" thick Board (N/A with –RF1)



LEAD STYLE

-05.75

-PC4 OPTION



(0,70) (3,56)140

END

OPTION

PC4

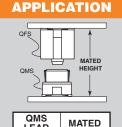
-RF1

= One RF

Plug per End (-05.75 only,

not available

with -PC4)



QMS LEAD STYLE	MATED HEIGHT*
-05.75	10 mm
-06.75	11 mm
*Processing conditions will affect mated height.	

Due to technical progress, all designs, specifications and components are subject to change without notice.

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